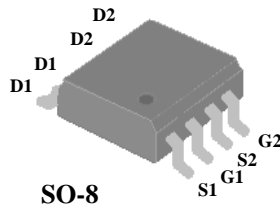




- ▼ Simple Drive Requirement
- ▼ Low On-resistance
- ▼ Fast Switching Performance
- ▼ RoHS Compliant & Halogen-Free

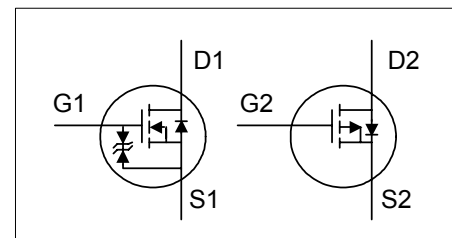


|      |              |              |
|------|--------------|--------------|
| N-CH | $BV_{DSS}$   | 30V          |
|      | $R_{DS(ON)}$ | 20m $\Omega$ |
|      | $I_D$        | 8A           |
| P-CH | $BV_{DSS}$   | -30V         |
|      | $R_{DS(ON)}$ | 60m $\Omega$ |
|      | $I_D$        | -4.6A        |

## Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SO-8 package is widely preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.



## Absolute Maximum Ratings @ $T_J=25^\circ\text{C}$ (unless otherwise specified)

| Symbol                     | Parameter                                   | Rating     |           | Units            |
|----------------------------|---|------------|-----------|------------------|
|                            |   | N-channel  | P-channel |                  |
| $V_{DS}$                   | Drain-Source Voltage                        | 30         | -30       | V                |
| $V_{GS}$                   | Gate-Source Voltage                         | $\pm 20$   | $\pm 20$  | V                |
| $I_D@T_A=25^\circ\text{C}$ | Drain Current <sup>3</sup> , $V_{GS}$ @ 10V | 8.0        | -4.6      | A                |
| $I_D@T_A=70^\circ\text{C}$ | Drain Current <sup>3</sup> , $V_{GS}$ @ 10V | 6.3        | -3.7      | A                |
| $I_{DM}$                   | Pulsed Drain Current <sup>1</sup>           | 20         | -20       | A                |
| $P_D@T_A=25^\circ\text{C}$ | Total Power Dissipation                     | 2          |           | W                |
| $T_{STG}$                  | Storage Temperature Range                   | -55 to 150 |           | $^\circ\text{C}$ |
| $T_J$                      | Operating Junction Temperature Range        | -55 to 150 |           | $^\circ\text{C}$ |

## Thermal Data

| Symbol | Parameter   | Value | Unit                      |
|--------|---|-------|---------------------------|
| Rthj-a | Maximum Thermal Resistance, Junction-ambient <sup>3</sup> | 62.5  | $^\circ\text{C}/\text{W}$ |



# AP4501AGEM-HF

## N-CH Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol       | Parameter                                      | Test Conditions               | Min. | Typ. | Max. | Units      |
|--------------|--|-------------------------------|------|------|------|------------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=250\mu A$     | 30   | -    | -    | V          |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=10V, I_D=8A$          | -    | -    | 20   | m $\Omega$ |
|              |  | $V_{GS}=4.5V, I_D=4A$         | -    | -    | 28   | m $\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage                         | $V_{DS}=V_{GS}, I_D=250\mu A$ | 1    | -    | 3    | V          |
| $g_{fs}$     | Forward Transconductance                       | $V_{DS}=10V, I_D=8A$          | -    | 15   | -    | S          |
| $I_{DSS}$    | Drain-Source Leakage Current                   | $V_{DS}=24V, V_{GS}=0V$       | -    | -    | 10   | $\mu A$    |
| $I_{GSS}$    | Gate-Source Leakage                            | $V_{GS}=\pm 20V, V_{DS}=0V$   | -    | -    | +30  | $\mu A$    |
| $Q_g$        | Total Gate Charge                              | $I_D=8A$                      | -    | 7    | 11.2 | nC         |
| $Q_{gs}$     | Gate-Source Charge                             | $V_{DS}=15V$                  | -    | 2    | -    | nC         |
| $Q_{gd}$     | Gate-Drain ("Miller") Charge                   | $V_{GS}=4.5V$                 | -    | 3    | -    | nC         |
| $t_{d(on)}$  | Turn-on Delay Time                             | $V_{DS}=15V$                  | -    | 7    | -    | ns         |
| $t_r$        | Rise Time                                      | $I_D=1A$                      | -    | 5    | -    | ns         |
| $t_{d(off)}$ | Turn-off Delay Time                            | $R_G=3.3\Omega$               | -    | 18   | -    | ns         |
| $t_f$        | Fall Time                                      | $V_{GS}=10V$                  | -    | 3    | -    | ns         |
| $C_{iss}$    | Input Capacitance                              | $V_{GS}=0V$                   | -    | 800  | 1280 | pF         |
| $C_{oss}$    | Output Capacitance                             | $V_{DS}=15V$                  | -    | 100  | -    | pF         |
| $C_{rss}$    | Reverse Transfer Capacitance                   | $f=1.0\text{MHz}$             | -    | 80   | -    | pF         |
| $R_g$        | Gate Resistance                                | $f=1.0\text{MHz}$             | -    | 1.3  | 2.6  | $\Omega$   |

## Source-Drain Diode

| Symbol   | Parameter                       | Test Conditions       | Min. | Typ. | Max. | Units |
|----------|---------------------------------|-----------------------|------|------|------|-------|
| $V_{SD}$ | Forward On Voltage <sup>2</sup> | $I_S=1.7A, V_{GS}=0V$ | -    | -    | 1.2  | V     |
| $t_{rr}$ | Reverse Recovery Time           | $I_S=8A, V_{GS}=0V,$  | -    | 15   | -    | ns    |
| $Q_{rr}$ | Reverse Recovery Charge         | $di/dt=100A/\mu s$    | -    | 8    | -    | nC    |



**P-CH Electrical Characteristics @T<sub>j</sub>=25°C(unless otherwise specified)**

| Symbol              | Parameter                                      | Test Conditions   | Min. | Typ. | Max. | Units |
|---------------------|--|---|------|------|------|-------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA               | -30  | -    | -    | V     |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =-10V, I <sub>D</sub> =-4A                | -    | -    | 60   | mΩ    |
|                     |  | V <sub>GS</sub> =-5V, I <sub>D</sub> =-2A                 | -    | -    | 150  | mΩ    |
| V <sub>GS(th)</sub> | Gate Threshold Voltage                         | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA | -1.7 | -    | -3   | V     |
| g <sub>fs</sub>     | Forward Transconductance                       | V <sub>DS</sub> =-10V, I <sub>D</sub> =-4A                | -    | 9    | -    | S     |
| I <sub>DSS</sub>    | Drain-Source Leakage Current                   | V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V                | -    | -    | -10  | uA    |
| I <sub>GSS</sub>    | Gate-Source Leakage                            | V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V                | -    | -    | +100 | nA    |
| Q <sub>g</sub>      | Total Gate Charge                              | I <sub>D</sub> =-4A                                       | -    | 6.5  | 10.4 | nC    |
| Q <sub>gs</sub>     | Gate-Source Charge                             | V <sub>DS</sub> =-15V                                     | -    | 2    | -    | nC    |
| Q <sub>gd</sub>     | Gate-Drain ("Miller") Charge                   | V <sub>GS</sub> =-4.5V                                    | -    | 3    | -    | nC    |
| t <sub>d(on)</sub>  | Turn-on Delay Time                             | V <sub>DS</sub> =-15V                                     | -    | 9    | -    | ns    |
| t <sub>r</sub>      | Rise Time                                      | I <sub>D</sub> =-1A                                       | -    | 5.5  | -    | ns    |
| t <sub>d(off)</sub> | Turn-off Delay Time                            | R <sub>G</sub> =3.3Ω                                      | -    | 19   | -    | ns    |
| t <sub>f</sub>      | Fall Time                                      | V <sub>GS</sub> =-10V                                     | -    | 6    | -    | ns    |
| C <sub>iss</sub>    | Input Capacitance                              | V <sub>GS</sub> =0V                                       | -    | 600  | 960  | pF    |
| C <sub>oss</sub>    | Output Capacitance                             | V <sub>DS</sub> =-15V                                     | -    | 105  | -    | pF    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                   | f=1.0MHz  | -    | 90   | -    | pF    |
| R <sub>g</sub>      | Gate Resistance                                | f=1.0MHz  | -    | 8    | 16   | Ω     |

**Source-Drain Diode**

| Symbol          | Parameter                       | Test Conditions                            | Min. | Typ. | Max. | Units |
|-----------------|---------------------------------|--|------|------|------|-------|
| V <sub>SD</sub> | Forward On Voltage <sup>2</sup> | I <sub>S</sub> =-1.7A, V <sub>GS</sub> =0V | -    | -    | -1.2 | V     |
| t <sub>rr</sub> | Reverse Recovery Time           | I <sub>S</sub> =-4A, V <sub>GS</sub> =0V,  | -    | 18   | -    | ns    |
| Q <sub>rr</sub> | Reverse Recovery Charge         | di/dt=100A/μs                              | -    | 12   | -    | nC    |

**Notes:**

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board, t ≤ 10s ; 135 °C/W when mounted on Min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

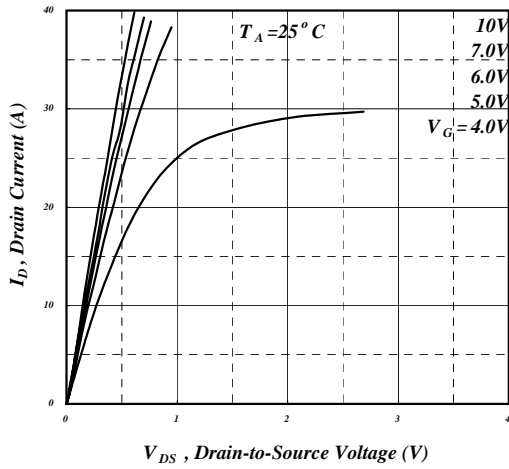
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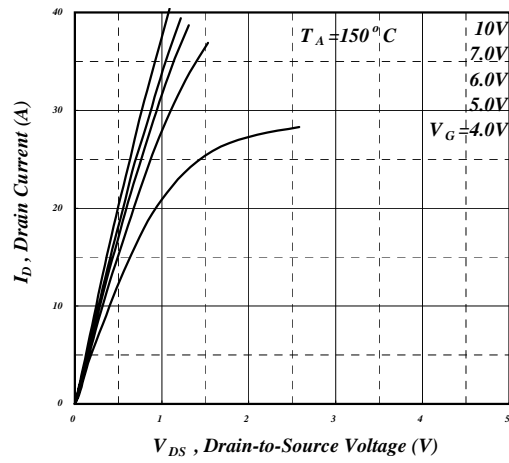
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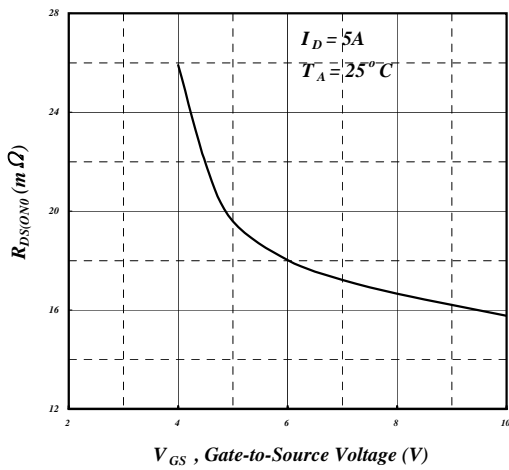
## N-Channel



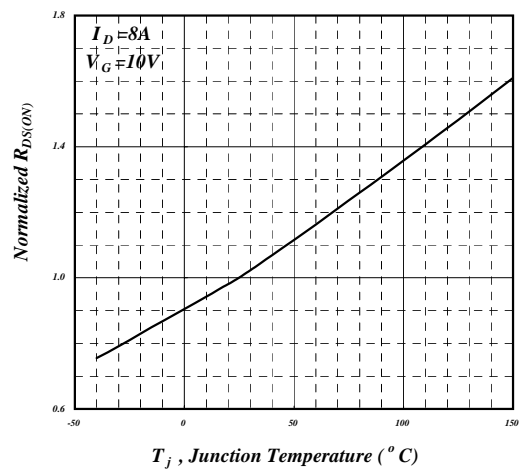
**Fig 1. Typical Output Characteristics**



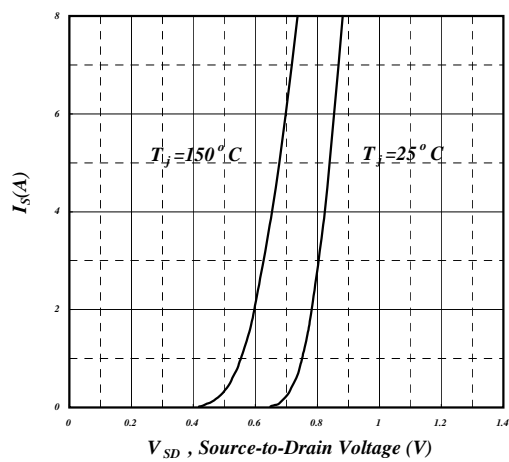
**Fig 2. Typical Output Characteristics**



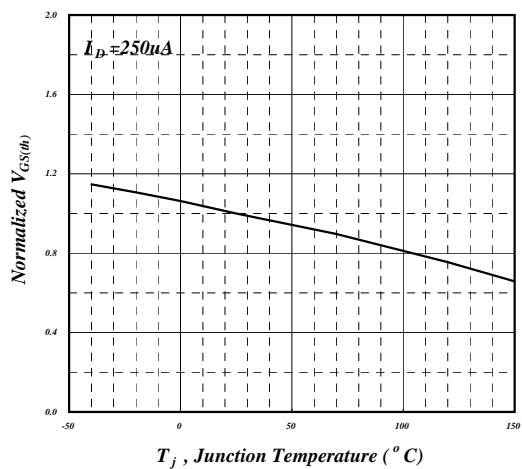
**Fig 3. On-Resistance v.s. Gate Voltage**



**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



**Fig 5. Forward Characteristic of Reverse Diode**



**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



N-Channel

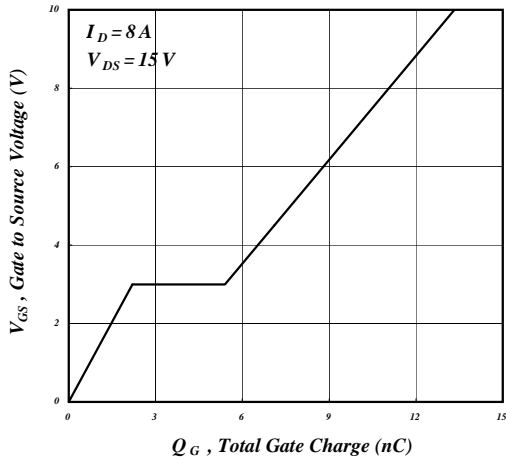


Fig 7. Gate Charge Characteristics

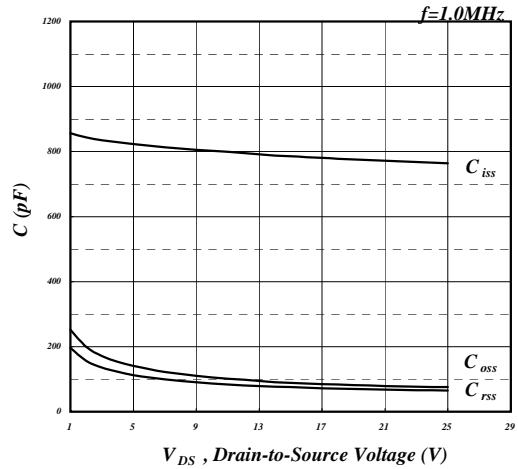


Fig 8. Typical Capacitance Characteristics

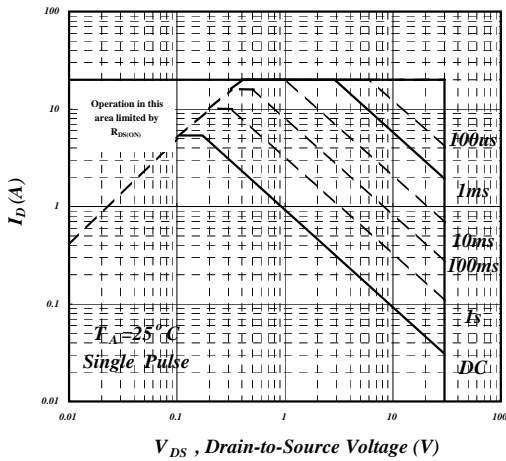


Fig 9. Maximum Safe Operating Area

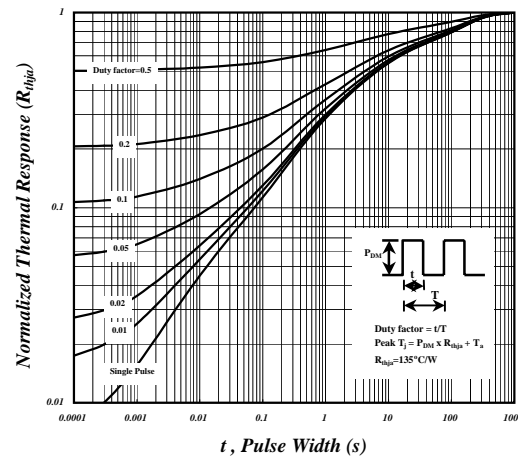


Fig 10. Effective Transient Thermal Impedance

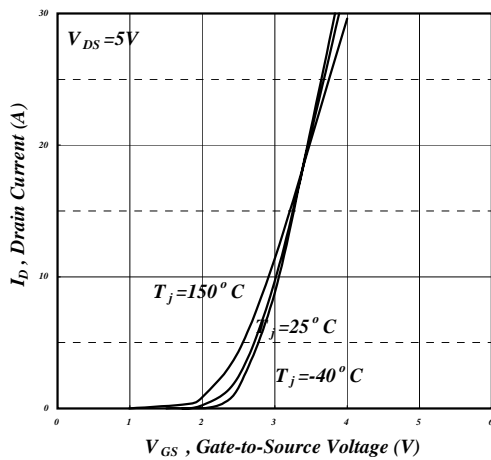


Fig 11. Transfer Characteristics

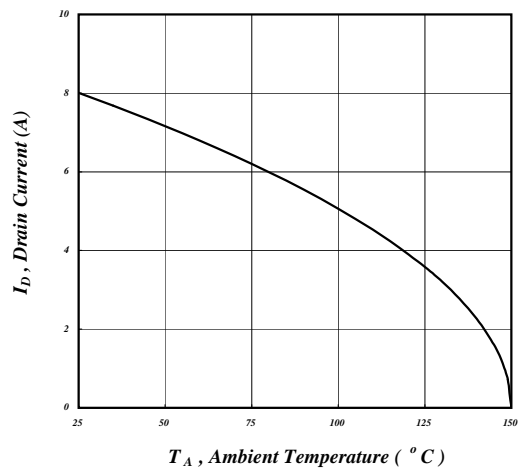


Fig 12. Drain Current v.s. Ambient Temperature



# AP4501AGEM-HF

## P-Channel

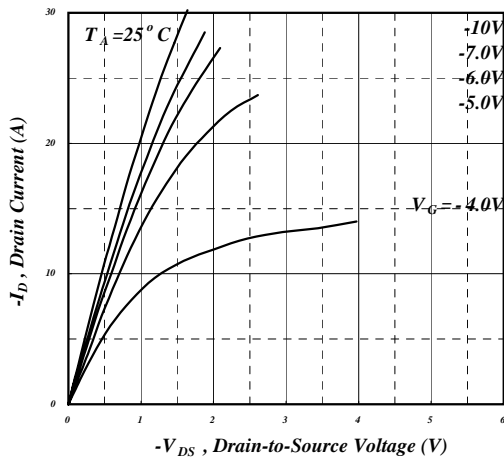


Fig 1. Typical Output Characteristics

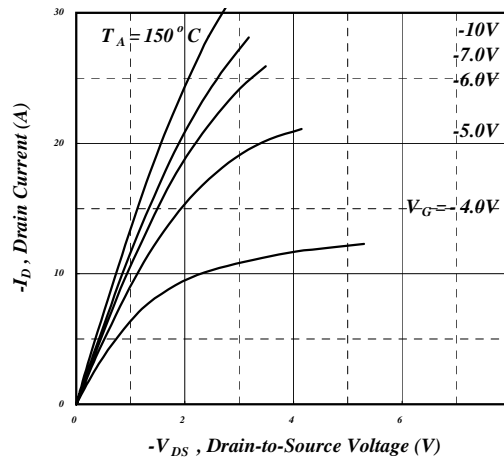


Fig 2. Typical Output Characteristics

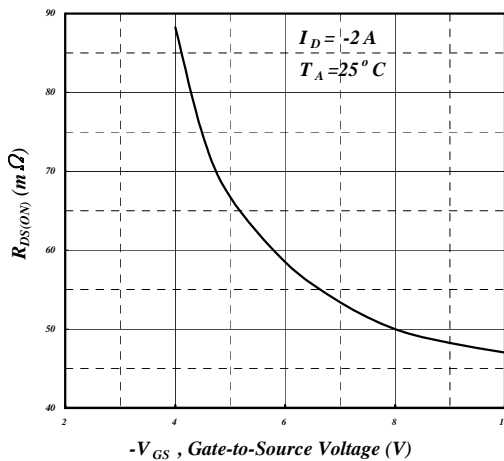


Fig 3. On-Resistance v.s. Gate Voltage

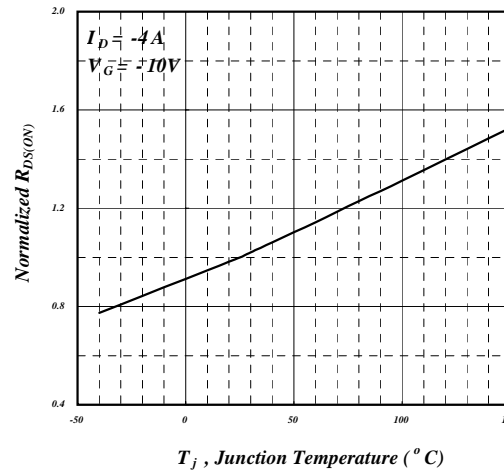


Fig 4. Normalized On-Resistance v.s. Junction Temperature

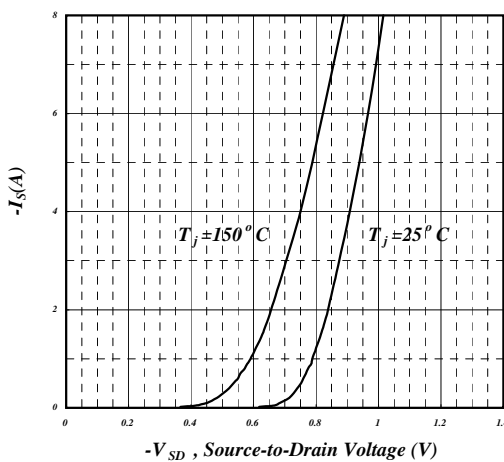


Fig 5. Forward Characteristic of Reverse Diode

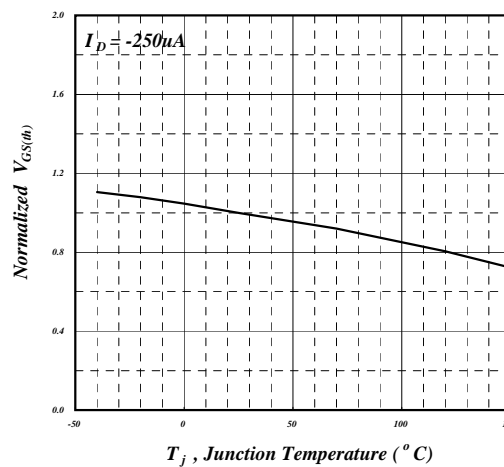


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



## P-Channel

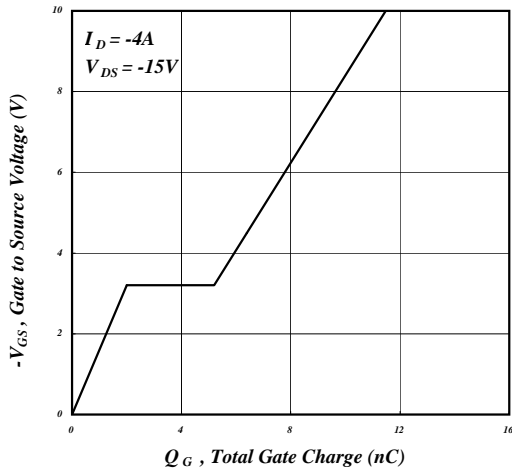


Fig 7. Gate Charge Characteristics

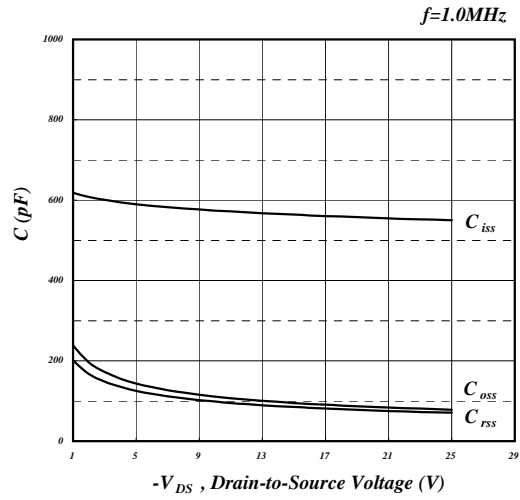


Fig 8. Typical Capacitance Characteristics

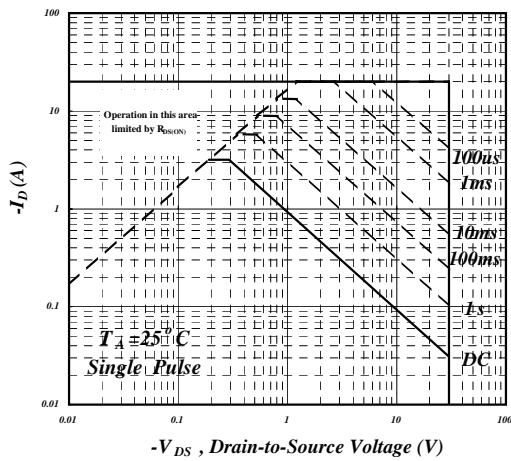


Fig 9. Maximum Safe Operating Area

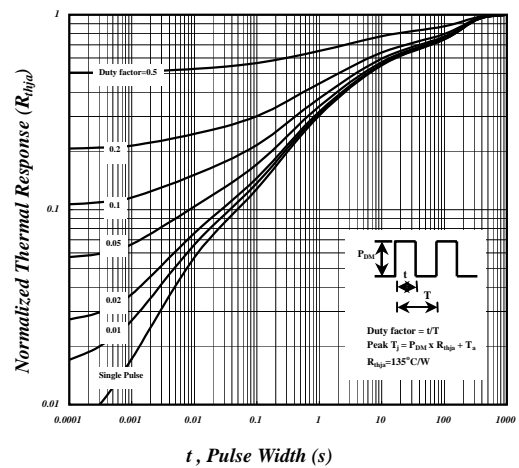


Fig 10. Effective Transient Thermal Impedance

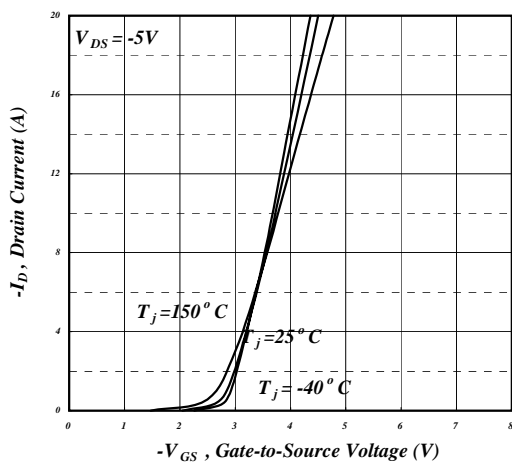


Fig 11. Transfer Characteristics

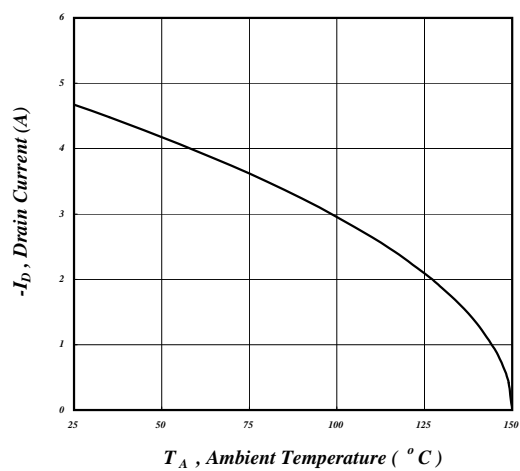


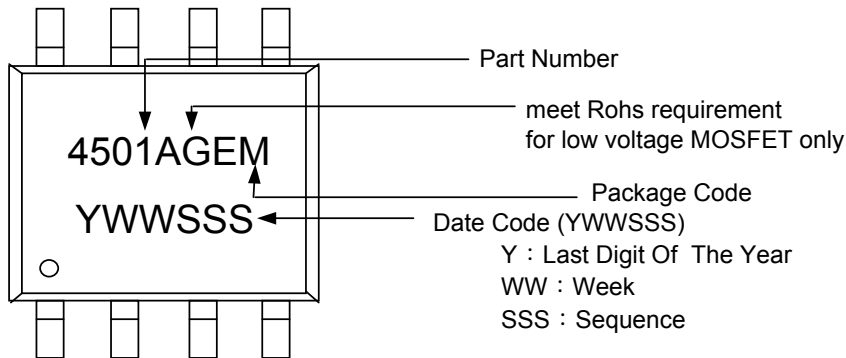
Fig 12. Drain Current v.s. Ambient Temperature



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